

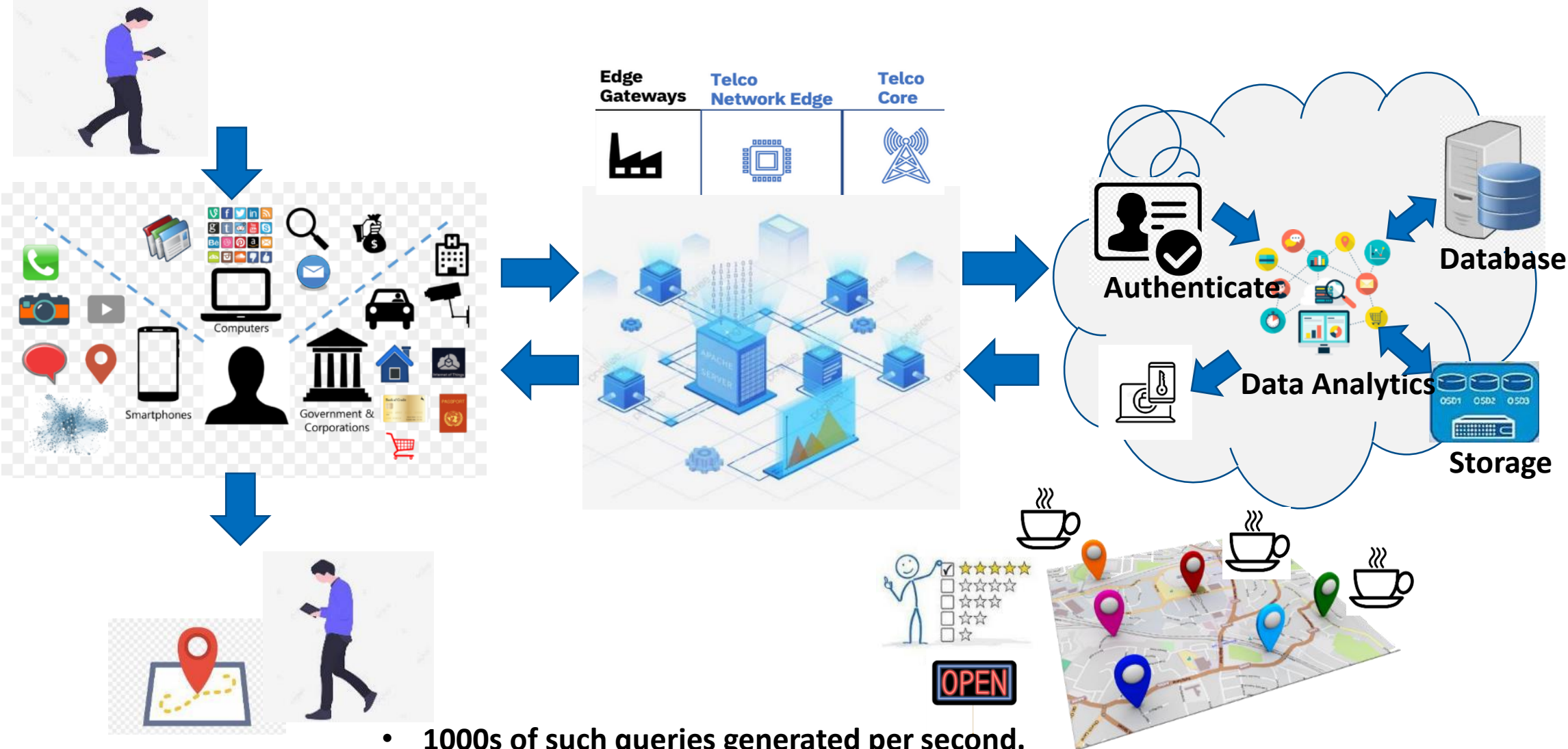
# Computational Memory: Moving compute near the Data

Presented by

Pekon Gupta <Pekon.Gupta@smartm.com>

Arthur Sainio <Arthur.Sainio@smartm.com>

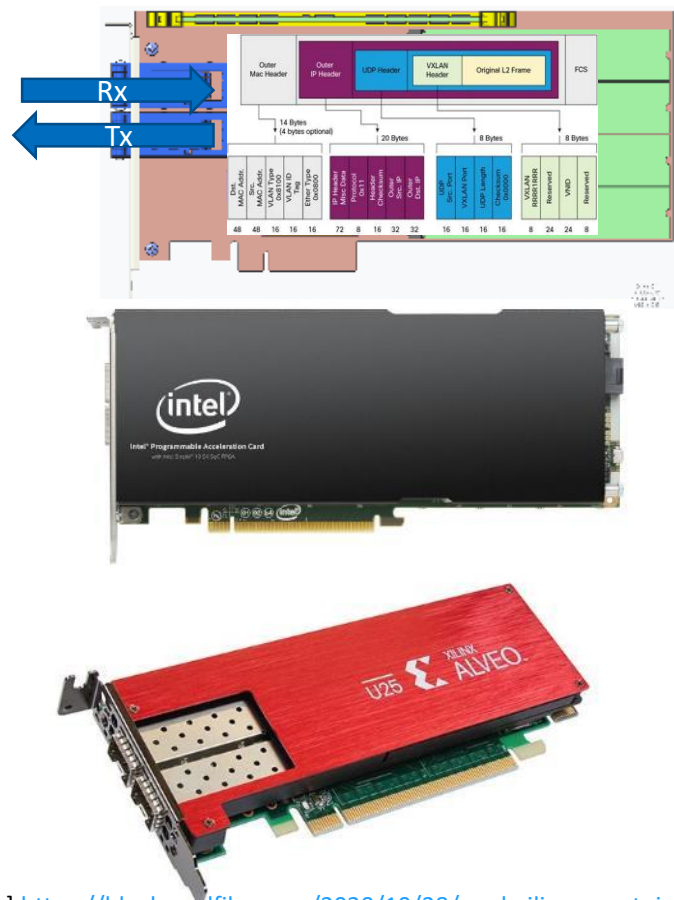
# Data Flow: Logical View



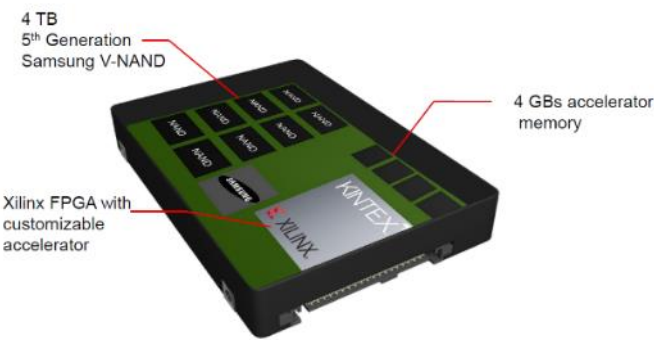
- 1000s of such queries generated per second.
- Result should be returned within few seconds.

# Types of Hardware Accelerators

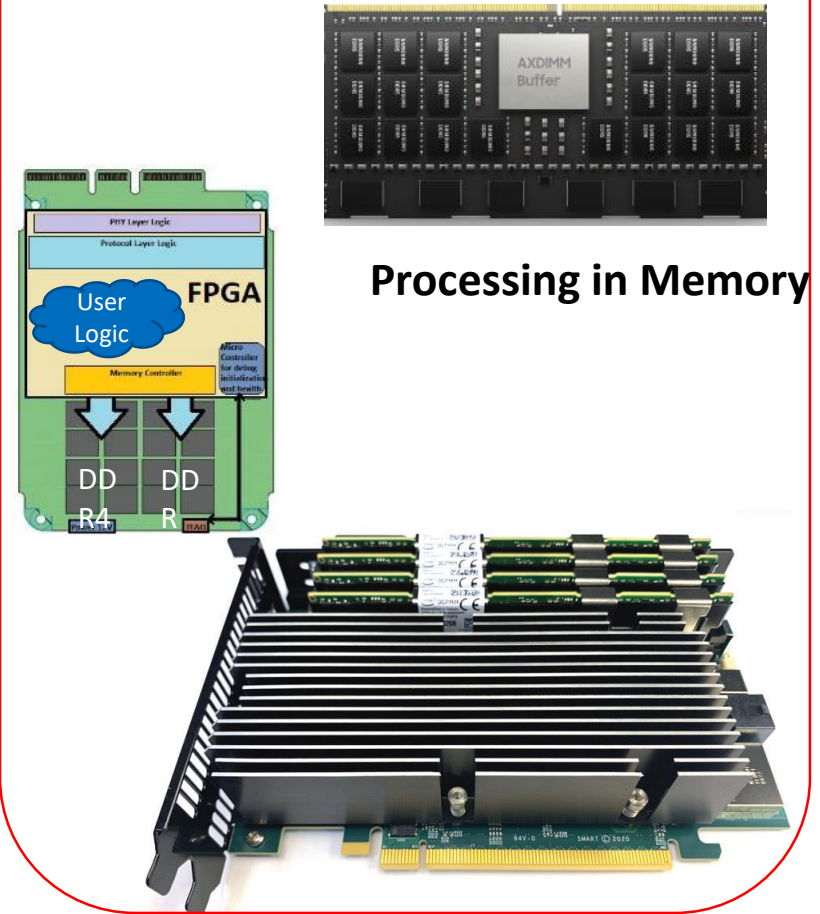
## Network Accelerators (Smart NIC [1a/1b])



## Storage Accelerators (Computational Storage<sup>[2a,2b]</sup>) SmartSSD® CSD



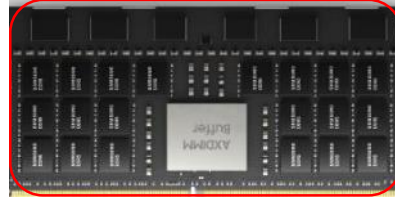
## Memory Accelerators (Computational Memory<sup>[3a]</sup>)



[1a] <https://blocksandfiles.com/2020/10/28/amd-xilinx-smartnic-data-centre/>  
[1b] <https://www.servethehome.com/intel-fpga-pac-d5005-high-end-drop-in-accelerator-launched>  
[2a] <https://www.servethehome.com/xilinx-samsung-smartssd-computational-storage-drive-launched/>  
[2b] <https://www.servethehome.com/intel-fpga-pac-d5005-high-end-drop-in-accelerator-launched/>  
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[3a] <https://tekdeeps.com/samsung-also-sees-the-future-in-memories-that-also-perform-calculations/>

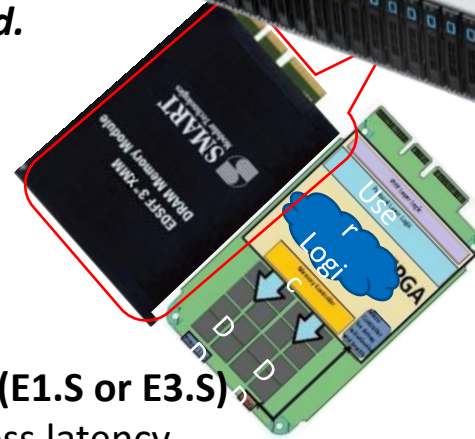


# Form-factors for Computational Memory Devices (CMD)



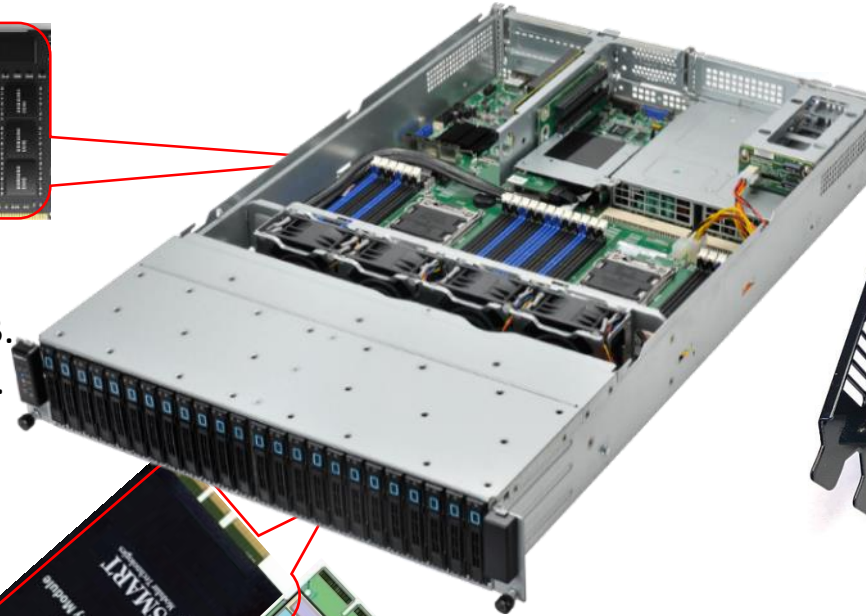
## CMD in DIMM

- ✓ Low latency as directly attached to DDR bus
- ❖ Memory capacity limited by Thermal and PCB.
- ❖ PCB real-estate design limits the acceleration.
- ❖ *May bring down the speed of entire DDR channel if not running at maximum speed.*



## CMD in EDSFF (E1.S or E3.S)

- ❖ Higher access latency
- ✓ High Memory capacity.
- ✓ **Scalable and Hot pluggable**
- ✓ Sustain up to 40W TDP for E3.S 2T



## CMD in PCIe Card Electro Mechanical (CEM)

- ❖ High access latency.
- ✓ Very High Memory capacity. (In Tera Bytes)
- ✓ Scalable. Allows user to choose Memory capacity and select DIMM.
- ✓ Offload Heavy functions. Can scale up to 100s of Watt of TDP.
- ✓ **CPU and Platform Agnostic**

# Optane based Memory accelerator

Optane Memory Expansion and Memory Accelerator



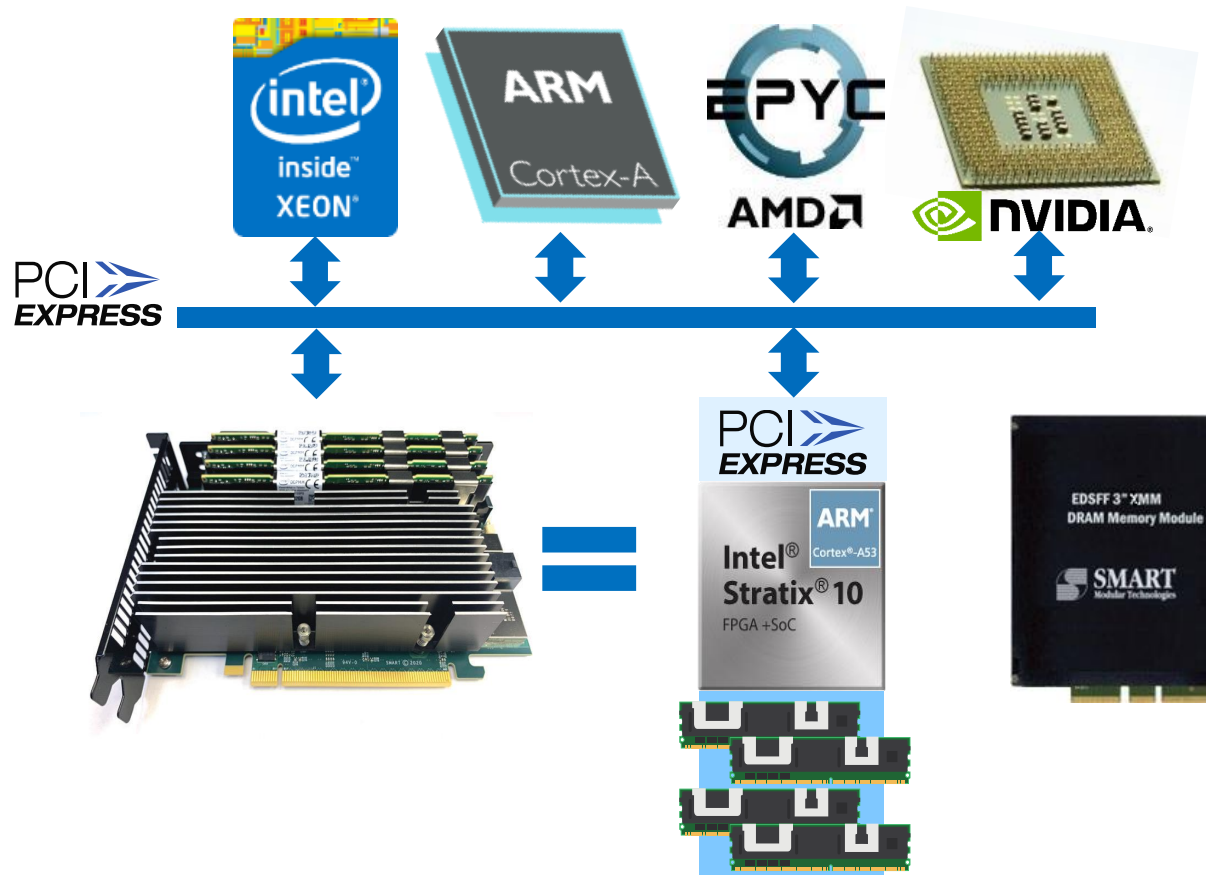
Wow! **Computational Memory Device can**

- Offload Host CPU
  - Run analytics on parallel nodes
  - Offload without any custom stack
- System Integrator



Feature	Description
Host Interface	<ul style="list-style-type: none"><li>• PCIe Gen4 x16</li></ul>
Memory	<ul style="list-style-type: none"><li>• Four DDR4 DIMM Slots (2 DIMMs Per Ch)</li><li>• Up to 2TB (4 x 512GB) Intel Optane Persistent Memory DIMM or</li><li>• Up to 512GB (2 x 256GB) DDR4 RDIMM</li></ul>
Form Factor	<ul style="list-style-type: none"><li>• FHHL (Full-Height Half-Length) Dual Slot</li></ul>
Acceleration	<ul style="list-style-type: none"><li>• Hardened Quad core ARM A53 with dedicated memory.</li><li>• Hardware engines for compression, encryption and search can be implemented on Intel Stratix-10 DX FPGA</li></ul>
Power	<ul style="list-style-type: none"><li>• Less than 150W TDP for Memory expansion and Acceleration.</li></ul>
Cooling	<ul style="list-style-type: none"><li>• Passive cooling. Airflow requirement up to 45 CFM</li></ul>

# Processing in Memory (PIM): Moving compute near the Data



## CPU Agnostic

- Abstraction of Memory technology (DDR4, DDR5, LPDDR-X or any Persistent Memory) from CPU architecture
- Memory can be upgraded independent of CPU architecture

## Improve Utilization, Reduce Copy and discard.

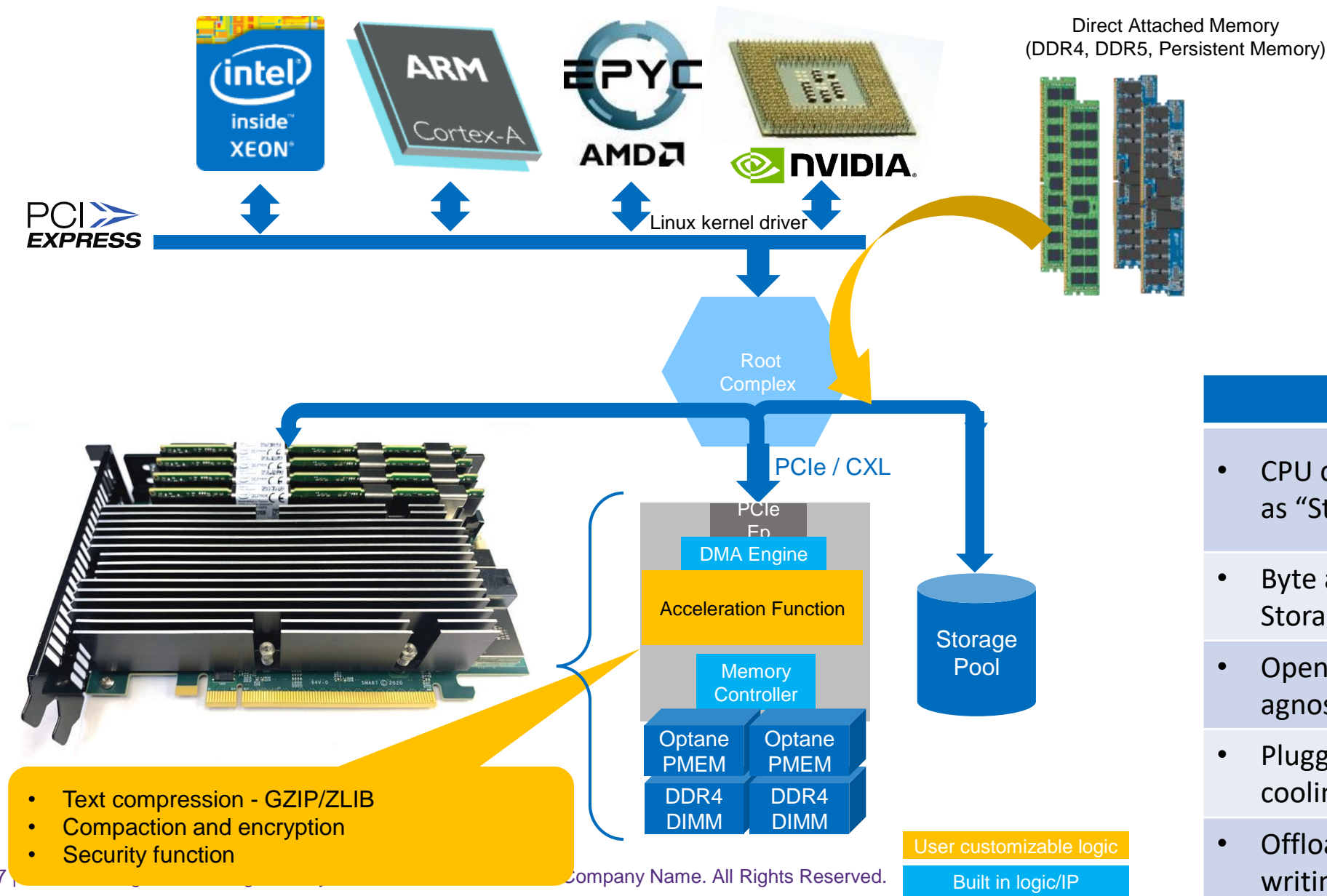
- Pre filter, search and organize the data before copying.
- Processing on multiple data-sets in parallel.
- Free up CPU from mundane tasks.

## Scalability

- PCIe CEM allow standard off-the-shelf Memory DIMMs for both Memory acceleration and expansion
- EDSFF devices are Hot Pluggable.



# Computational Memory Device as Storage Cache



Benefits
<ul style="list-style-type: none"><li>CPU can use 2TB of “persistent” Memory as “Storage Cache”.</li></ul>
<ul style="list-style-type: none"><li>Byte addressable Memory Tier in between Storage and DDR4/DDR5 Memory DIMMs.</li></ul>
<ul style="list-style-type: none"><li>Open source driver support and platform agnostic attachment.</li></ul>
<ul style="list-style-type: none"><li>Pluggable in existing chassis with passive cooling.</li></ul>
<ul style="list-style-type: none"><li>Offload in-line functions while read or writing data to storage.</li></ul>

# Comparing the numbers on real hardware: Kestral



Parameters	Samsung NVMe SSD	Intel Optane NVMe SSD	Kestral PCIe-Gen3-x16 (4 Apache Pass/2DPC)	Kestral PCIe-Gen4-x8 (4 Apache Pass/2DPC)
Capacity	2TB	2x0.8TB=1.6TB	2TB	2TB
Host Interface	2 x (PCIe Gen4 x4)	2 x (PCIe Gen4 x4)	PCIe Gen3 x16	PCIe Gen4 x8
Random Read Perf (GB/s)**	2x2.72=5.44	2x6.2=12.4	4.3	8.0***
Random Write Perf (GB/s)**	2x2.52=5.04	2x6.4=12.8	2.4	7.0***
Sequential Read Perf (GB/s)**	2x7.0=14	2x7.4=14.8	9.7	12.2
Sequential Write Perf (GB/s)**	2x5.1=10.2	2x7.4=14.8	9.7	9.9
Read Latency (QD=1)*	20us/(Z-NAND SSD)	<6us	TBD	< 0.3us
Write Latency (QD=1)*	16us(Z-NAND SSD)	<6us	TBD	< 0.5us

Higher is better

Lower is better

\*\* Converting IOPS to GB/s assuming IO size = 4KB. to convert IOPS to GB/s. Also assuming two x4 SSD connected in parallel to compare with PCIe-Gen4-x8.

\*\*\* Projected numbers extrapolated from PCIe-Gen3-x15 and PCIe-Gen4-x8 testing.

• Samsung NVMe SSD: Samsung 980 Pro <https://www.samsung.com/us/computing/memory-storage/solid-state-drives/980-pro-pcie-4-0-nvme-ssd-2tb-mz-v8p2t0b-ami/#spec>

Samsung Z-NAND <https://semiconductor.samsung.com/resources/brochure/Ultra-Low%20Latency%20with%20Samsung%20Z-NAND%20SSD.pdf>

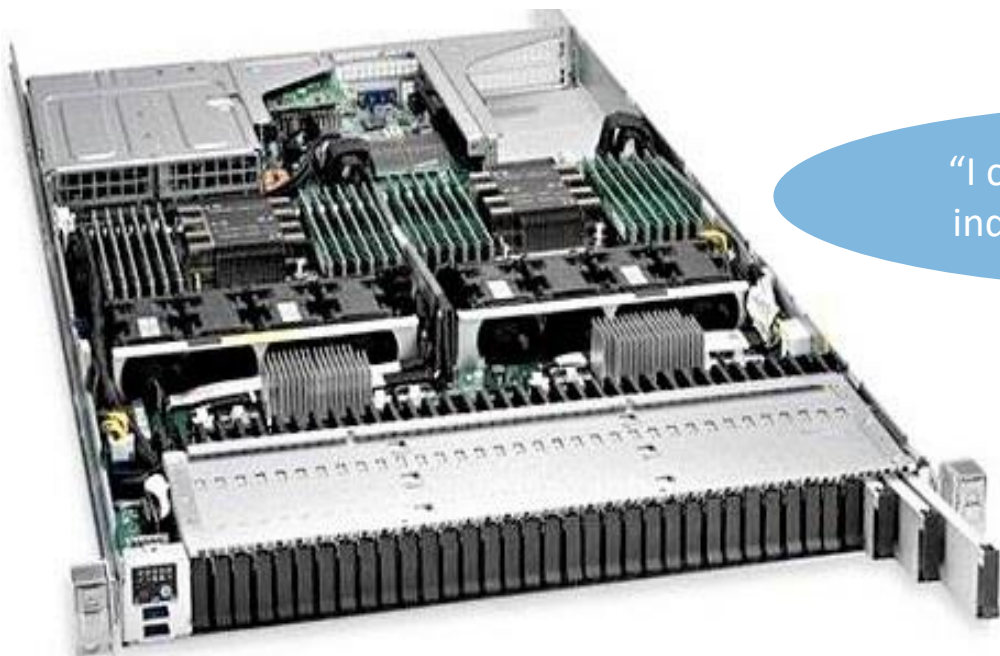
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Intel Optane NVMe SSD: <https://www.intel.com/content/www/us/en/products/docs/memory-storage/solid-state-drives/data-center-ssds/optane-ssd-p5800x-p5801x-brief.html>





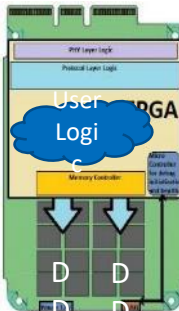
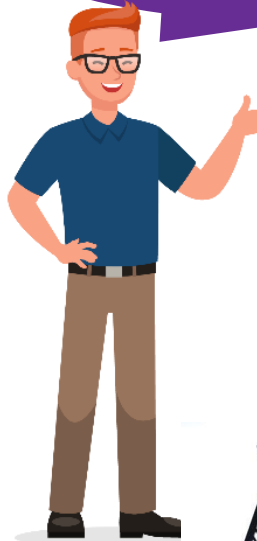
# Summarizing benefits of Computational Memory architecture



“I can upgrade the memory independent of Processor”

“I can do more with less”

“Frees CPU cycles and reduces wasteful copy and discards.”



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